Features

- 64-Mbit Flash and 16-Mbit PSRAM
- Single 66-ball (8 mm x 10 mm x 1.2 mm) CBGA Package
- 2.7V to 3.1V Operating Voltage

Flash

- Single Voltage Read/Write Operation: 2.65V to 3.6V
- Access Time 70 ns
- Sector Erase Architecture
 - One Hundred Twenty-seven 32K Word Sectors with Individual Write Lockout
 - Eight 4K Word Sectors with Individual Write Lockout
- Fast Word Program Time 10 μs
- Typical Sector Erase Time: 32K Word Sectors 700 ms; 4K Word Sectors 100 ms
- Suspend/Resume Feature for Erase and Program
 - Supports Reading and Programming Data from Any Sector by Suspending Erase of a Different Sector
 - Supports Reading Any Word by Suspending Programming of Any Other Word
- Low-power Operation
 - 10 mA Active
 - 15 µA Standby
- VPP Pin for Write Protection and Accelerated Program Operation
- WP Pin for Sector Protection
- RESET Input for Device Initialization
- Flexibel Sector Protection
- Top or Bottom Boot Block Configuration Available
- 128-bit Protection Register
- Minimum 100,000 Erase Cycles
- Common Flash Interface (CFI)

PSRAM

- 16-megabit (1M x 16)
- 2.7V to 3.1V V_{CC}
- 70 ns Access Time

Device Number	Flash Boot Location	Flash Plane Configuration	PSRAM Configuration	
AT52BC6402D	Bottom	64M (4M x 16)	16M (1M x 16)	
AT52BC6402DT	Тор	64M (4M x 16)	16M (1M x 16)	

Flash & PSRAM Datasheets

Datasheets	PDF File
64M Flash Memory: AT49BV640D(T)	Acrobat Document
16M PSRAM: 2FHY64UD16161B	Acrobat Document



64-megabit
Flash +
16-megabit
PSRAM
Stack Memory

AT52BC6402D AT52BC6402DT

Preliminary

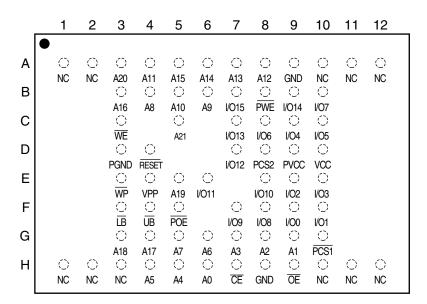




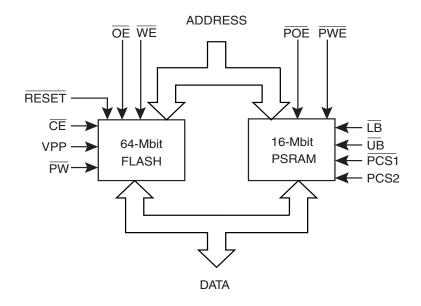
1. Pin Configuration

Pin Name	Function
A0 - A19, A21	Common Address Input for 16M PSRAM/Flash, Flash Address Input
CE	Flash Chip Enable
ŌĒ	Flash Output Enable
WE	Flash Write Enable
RESET	Flash Reset
PW	Flash Write Protect
VPP	Flash Power Supply for Accelerated Program Operation
VCC	Flash Power
GND	Flash Ground
I/O0 - I/O15	Data Inputs/Outputs
NC	No Connect
LB	PSRAM Lower Byte
ŪB	PSRAM Upper Byte
PVCC	PSRAM Power
PGND	PSRAM Ground
PCS1	PSRAM Chip Select 1
PCS2	Low Power Modes
PWE	PSRAM Write Enable
POE	PSRAM Output Enable

2. AT52BC6402D(T) (Top View)



3. Block Diagram



4. Description

The AT52BC6402D(T) combines a 64-megabit Flash (4M x 16) and an 16-megabit PSRAM (organized as 1M x 16) in a stacked 66-ball CBGA package. The stacked modules operate at 2.7V to 3.1V in the extended temperature range.

5. Absolute Maximum Ratings

Temperature under Bias55° C to +	-85° C
Storage Temperature55° C to +1	50° C
All Input Voltages except V_{PP} (including NC Pins) with Respect to Ground0.2V to V_{CC}	+0.3V
Voltage on V _{PP} with Respect to Ground0.2V to +	10.0V
All Output Voltages with Respect to Ground0.2V to V _{CC}	+0.3V

*NOTICE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

6. DC and AC Operating Range

	AT52BC6402D(T)-70CU
Operating Temperature (Case)	-30° C - 85° C
V _{CC} Power Supply	2.7V to 3.1V





7. Flash Operating Modes

Mode	CE	ŌĒ	WE	RESET	V _{PP} ⁽²⁾	Ai	I/O	PSRAM Operation
Read	V_{IL}	V_{IL}	V _{IH}	V _{IH}	Х	Ai	D _{OUT}	
Program/Erase	V_{IL}	V_{IH}	V_{IL}	V _{IH}	V _{IHPP} (3)	Ai	D _{IN}	
Drogram Inhihit	V_{IL}	Х	V_{IH}	V_{IH}	X			PSRAM
Program Inhibit	V_{IL}	Χ	Х	Х	$V_{\rm ILPP}^{(4)}$			Must Be High-Z
Software Product	V _{IL}	V _{IL}	V _{IH}	V _{IH}	Х	A0 = V _{IL} , A1 - A19 = V _{IL}	Manufacturer Code	High-Z
Identification						$A0 = V_{IH}, A1 - A19 = V_{IL}$	Device Code	
Standby/Program Inhibit	V _{IH}	X ⁽¹⁾	Х	V _{IH}	Х	x	High Z	Any PSRAM
Output Disable	Х	V _{IH}	Х	V _{IH}	Х		High Z	Operation is Allowed
Reset	Х	Χ	Х	V _{IL}	Х	X	High Z	, mowod

Notes: 1. X can be V_{IL} or V_{IH}

2. The VPP pin can be tied to V_{CC} . For faster program operations, V_{PP} can be set to 9.5V \pm 0.5V.

3. V_{IHPP} (min) = 1.65V

4. V_{ILPP} (max) = 0.4V

8. Functional Description

PCS1	PCS2	POE	PWE	LB	ŪB	I/O0 - 7	I/O8 - 15	Mode	Power	Flash Operation								
Н	Н	X ⁽¹⁾	X ⁽¹⁾	X ⁽¹⁾	X ⁽¹⁾	High-Z	High-Z	Deselected	Standby	Any Flash								
X ⁽¹⁾	L	X ⁽¹⁾	X ⁽¹⁾	X ⁽¹⁾	X ⁽¹⁾	High-Z	High-Z	Deselected	Low-power Modes	Operation Allowed								
L ⁽¹⁾	Н	X ⁽¹⁾	X ⁽¹⁾	Н	Н	High-Z	High-Z	Output Disabled	Active									
	Н	Н	Н	L	X ⁽¹⁾	High-Z	High-Z	Output Disabled	Active									
L	Н	Н	Н	X ⁽¹⁾	L	High-Z	High-Z	Output Disabled	Active	-								
	L	L										L	Н	D _{OUT}	High-Z	Lower Byte Read	Active	
			L H	Н	Н	Н	Н	L	High-Z	D _{OUT}	Upper Byte Read	Active	Flash Must Be High Z					
				L	L	D _{OUT}	D _{OUT}	Word Read	Active									
L	Н			L	Н	D _{IN}	High-Z	Lower Byte Write	Active									
		X ⁽¹⁾	L	Н	L	High-Z	D _{IN}	Upper Byte Write	Active									
				L	L	D _{IN}	D _{IN}	Word Write	Active									

Note: 1. X means don't care (must be low or high state).

■ AT52BC6402D(T) Preliminary

9. Ordering Information

9.1 Green Package (Pb/Halide-free)

t _{ACC} (ns)	Ordering Code	Flash Boot Block	Flash Plane Architecture	PSRAM	Package	Operation Range
70	AT52BC6402D-70CU	Bottom	64M – Single Bank	1M x 16	66C7	Extended
70	AT52BC6402DT-70CU	Тор	64M – Single Bank	1W X 10	0007	(-30° to 85°C)

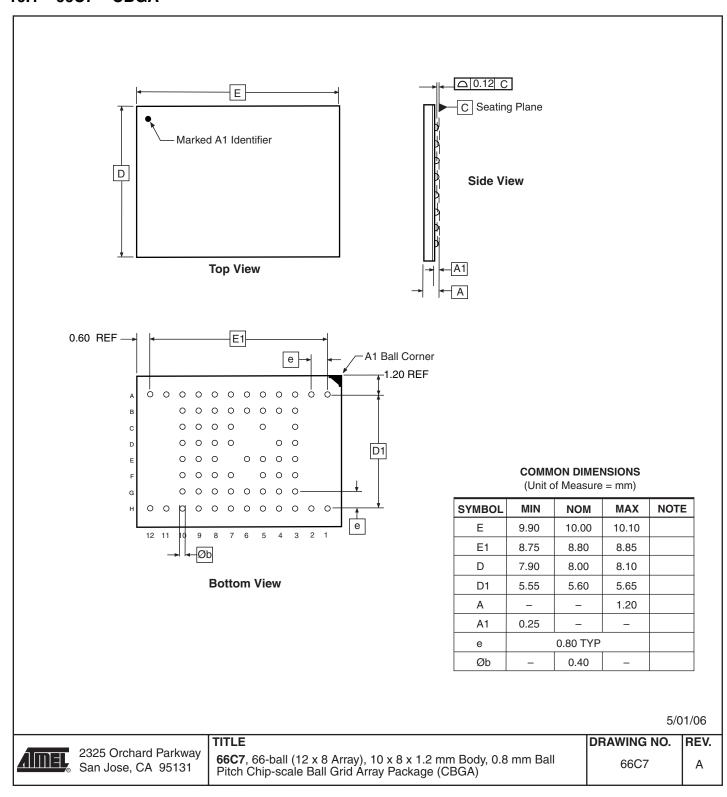
	Package Type
66C7	66-ball, Plastic Chip-size Ball Grid Array Package (CBGA)





10. Packaging Information

10.1 66C7 - CBGA



11. Revision History

Revision No.	History
Revision A – July 2006	Initial Release



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